

GaAs PIN Reflective Single-pole Double-throw Switch Chip, 2-20GHz

Performance characteristics

Frequency Range: 2 - 20 GHzInsertion loss: 0.8dB typ.

• Isolation: 48 dB typ.

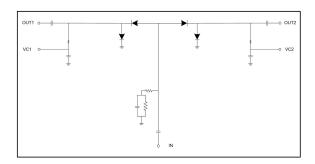
P-1dB: 28dBm @17GHz

• 500hm input / output

100% on-wafer testingChip size: 2.12 x 1.45 x 0.1mm

Silicon nitride passivation, scratch protection

Functional Block Diagram



Product Introduction

GSW210G is a GaAs PIN reflective single-pole double-throw switch chip with 50Ω matching at the input/output end, a frequency range of 2 to 20GHz, and -5V/+5V control. It has a built-in bias network and DC blocking capacitors, which is easy to use. It has excellent switching characteristics and port standing wave characteristics in the entire operating frequency range, and is very suitable for microwave hybrid integrated circuits, multi-chip modules, and low-power systems. The switch chip uses on-chip through-hole metallization technology to ensure good grounding, does not require additional grounding measures, and is simple and convenient to use. The back of the chip is metallized, which is suitable for eutectic sintering or conductive adhesive bonding processes.

Use restriction parameter ¹		
Maximum input voltage	2 5V	
Maximum input power	+33dBm CW	
Operating temperature	-55 ~ +85°C	
storage temperature	-65 ~ +150°C	

[1] Exceeding any of these maximum limits may cause permanent damage.

Electrical performance parameters (TA = +25°C)					
index	Minimum	Typical Value	Maximum	unit	
Frequency Range		2-20	GHz		
Insertion loss	-	0.8	1.3	dB	
Isolation	39	48	-	dB	
Input return loss	19	25	-	dB	
Output return loss	17	23	-	dB	
P-1dB @17GHz	-	28	-	dBm	
Switching speed	-	20	-	ns	

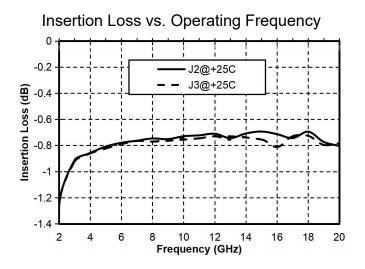
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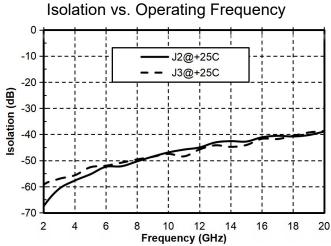
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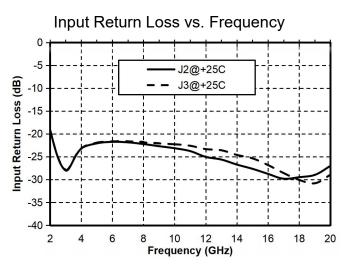


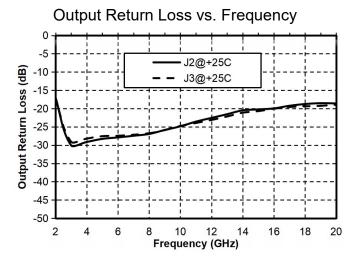
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Main index test curve









Typical Driver Connections

CONTROL LEVEL (DC CURRENT)		RF OUTPUT STATE	
VC1	VC2	OUT1(J2) - IN(J1)	OUT2(J 3) - IN(J1)
-10mA	+2 0mA	Low Loss	Isolation
+2 0mA	-10mA	Isolation Low Loss	

Note: V = +1.35 V, I = +20 mA; V = -3.2 V, I = -10 mA (including J1 on-chip resistor RIN = 50 ohm voltage divider)

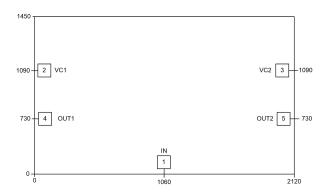
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Appearance structure

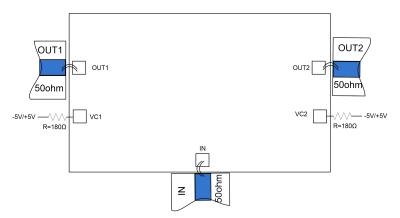


All units in the figure are micrometers

Bonding point definition

Bonding point number	Function Symbol	Functional Description
1	IN(J1)	RF input signal terminal
2.3	OUT2(J2), OUT3(J3)	RF output signal terminal
4, 5	VC1, VC2	Control Port
Chip bottom	GND	The bottom of the chip needs to be well grounded to RF
		and DC

Recommended circuit diagram



+5V is connected in series with R=180 ohm resistor, V = +1.35V, I = +20mA. -5V is connected in series with R=180 ohm resistor, V = -3.2V, I = -10mA.

Note: If you need to reduce power consumption, you need to connect +-5V /-5V in series with resistors of different resistance values. For example: +5V in series with R=370 ohm resistor: V=+1.3V, I=+10mA; -5V in series with R=180 ohm resistor V=-3.2V, I=-10mA. (Including the internal resistor RIN=50 ohm voltage divider at J1 end). Please contact the manufacturer for specific usage.

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